Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Sharp Microelectronics PC3Q65

For any questions, you can email us directly: sales@integrated-circuit.com

Datasheet of PC3Q65 - OPTOISOLTR 2.5KV 4CH DARL 16SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



PC3Q65 Series

PC3Q65 Series

*1-channel package type is also available. (model No. **PC3H5 Series**)

Mini-flat Half Pitch 4-channel Package Darlington Phototransistor Output Photocoupler



■ Description

PC3Q65 Series contains an IRED optically coupled to a phototransistor.

It is packaged in a 4 channel Mini-flat, Half pitch type.

Input-output isolation voltage(rms) is 2.5kV. CTR is MIN. 600% at input current of 1mA.

■ Features

- 4 channel Mini-flat Half pitch package (Lead pitch : 1.27mm)
- Double transfer mold package (Ideal for Flow Soldering)
- 3. Darlington phototransistor output (CTR : MIN. 600% at $I_F=1mA$, $V_{CE}=2V$)
- 4. Isolation voltage between input and output (V_{iso(rms)}=2.5kV)

■ Agency approvals/Compliance

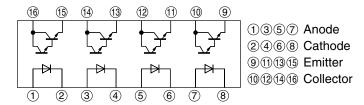
- Recognized by UL1577 (Double protection isolation), file No. E64380 (as model No. PC3Q65)
- 2. Approved by VDE, VDE0884 (as an option), file No. 5922UG (as model No. **PC3Q65**)
- 3. Package resin: UL flammability grade (94V-0)

■ Applications

- 1. Programmable controllers
- 2. Facsimiles
- 3. Telephones

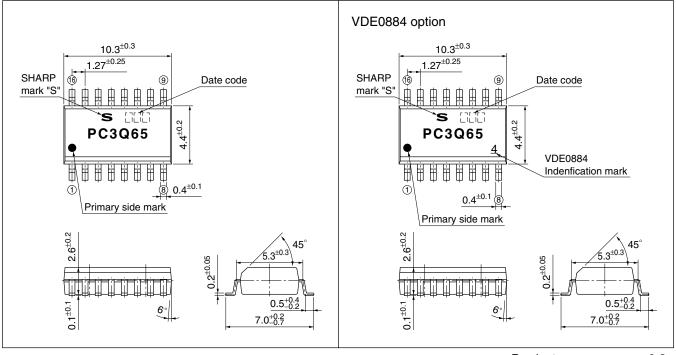
PC3Q65 Series

■ Internal Connection Diagram



■ Outline Dimensions

(Unit: mm)



Product mass: approx. 0.3g

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PC3Q65 Series

Date code (3 digit)

1st digit				2nd digit		3rd digit	
Year of production				Month of production		Week of production	
A.D.	Mark	A.D	Mark	Month	Mark	Week	Mark
1990	A	2002	P	January	1	1st	1
1991	В	2003	R	February	2	2nd	2
1992	С	2004	S	March	3	3rd	3
1993	D	2005	T	April	4	4th	4
1994	Е	2006	U	May	5	5, 6th	5
1995	F	2007	V	June	6		
1996	Н	2008	W	July	7		
1997	J	2009	X	August	8		
1998	K	2010	A	September	9		
1999	L	2011	В	October	0		
2000	M	2012	С	November	N		
2001	N	•	•	December	D		

repeats in a 20 year cycle

Country of origin Japan

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PC3Q65 Series

	$(T_a=25^{\circ}C)$			
	Parameter	Symbol	Rating	Unit
	Forward current	I_{F}	50	mA
Input	*1 Peak forward current	I_{FM}	1	A
In	Reverse voltage	V_R	6	V
	Power dissipation	P	70	mW
	Collector-emitter voltage	V_{CEO}	35	V
Output	Emitter-collector voltage	V_{ECO}	6	V
Out	Collector current	I_{C}	80	mA
	Collector power dissipation	P_{C}	150	mW
	Γotal power dissipation	P _{tot}	170	mW
(Operating temperature	Topr	-30 to +100	°C
Storage temperature		T_{stg}	-40 to +125	°C
*2 Isolation voltage		V _{iso (rms)}	2.5	kV
*3 Soldering temperature		T_{sol}	260	°C

^{*1} Pulse width≤100µs, Duty ratio : 0.001 *2 40 to 60%RH, AC for 1 minute, f=60Hz *3 For 10s

■ Electro-optical Characteristics

 $(T_a=25^{\circ}C)$

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		V_{F}	I _F =20mA	-	1.2	1.4	V
	Reverse current		I_R	$V_R=4V$	_	-	10	μΑ
	Terminal capacitance		C_{t}	V=0, f=1kHz	-	30	250	pF
	Collector dark current		I_{CEO}	$V_{CE}=10V, I_{F}=0$	_	-	1000	nA
Output	Collector-emitter breakdown voltage		$\mathrm{BV}_{\mathrm{CEO}}$	$I_{C}=0.1 \text{mA}, I_{F}=0$	35	-	-	V
	Emitter-collector breakdown voltage		$\mathrm{BV}_{\mathrm{ECO}}$	$I_E=10\mu A, I_F=0$	6	ı	-	V
	Collector current		I_{C}	$I_F=1mA$, $V_{CE}=2V$	6	16	75	mA
	Collector-emitter saturation voltage		V _{CE (sat)}	$I_F=1mA$, $I_C=2mA$	_	0.8	1.0	V
Transfer characteristics	Isolation resistance		$R_{\rm ISO}$	DC500V, 40 to 60%RH	5×10 ¹⁰	1×10 ¹¹	_	Ω
	Floating capacitance		C_{f}	V=0, $f=1MHz$	_	0.6	1.0	pF
	Response time	Rise time	t_r	$V_{CE}=2V$, $I_{C}=2mA$, $R_{I}=100\Omega$	-	60	300	μs
		Fall time	t_{f}	v _{CE} =2 v, i _C =2IIIA, K _L =100\$2	_	53	250	μs



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PC3Q65 Series

■ Model Line-up

Doolrogo	Taping		
Package	1 000pcs/reel		
VDE0884		Approved	
Model No.	PC3Q65	PC3Q65Y	

Please contact a local SHARP sales representative to inquire about production status and Lead-Free options.



PC3Q65 Series

Fig.1 Forward Current vs. Ambient Temperature

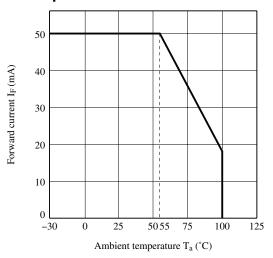


Fig.3 Collector Power Dissipation vs.
Ambient Temperature

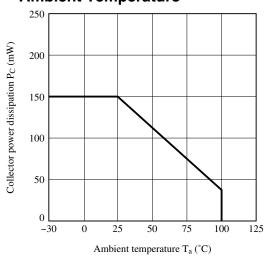


Fig.5 Peak Forward Current vs. Duty Ratio

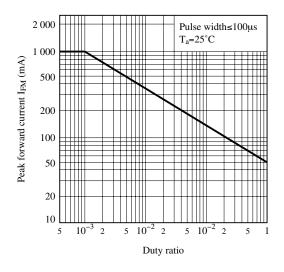


Fig.2 Diode Power Dissipation vs.
Ambient Temperature

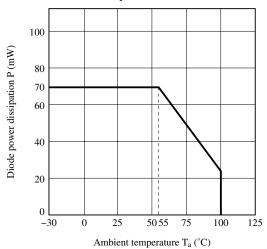


Fig.4 Total Power Dissipation vs. Ambient Temperature

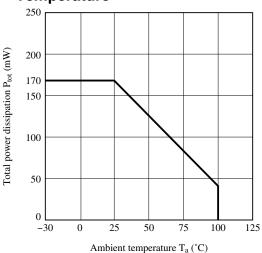
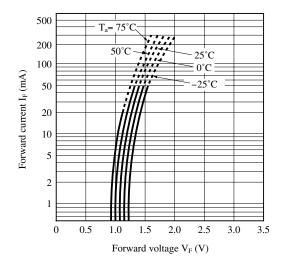


Fig.6 Forward Current vs. Forward Voltage





PC3Q65 Series

Fig.7 Current Transfer Ratio vs. Forward Current

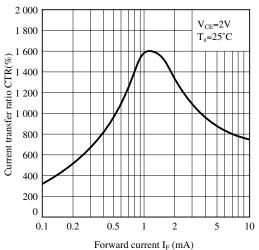


Fig.9 Relative Current Transfer Ratio vs.
Ambient Temperature

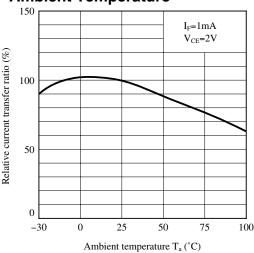


Fig.11 Collector Dark Current vs. Ambient Temperature

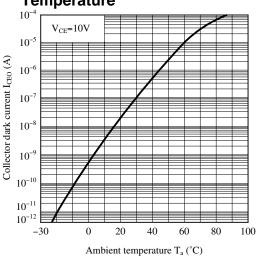


Fig.8 Collector Current vs. Collector-emitter Voltage

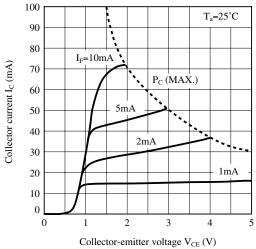


Fig.10 Collector - emitter Saturation Voltage vs. Ambient Temperature

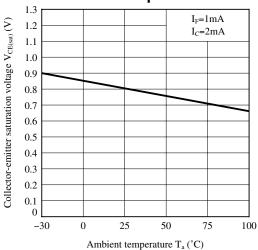
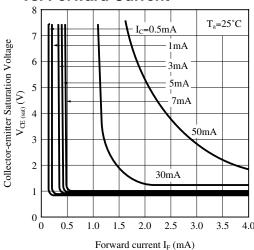


Fig.12 Collector-emitter Saturation Voltage vs. Forward Current



Remarks: Please be aware that all data in the graph are just for reference and not for guarantee.

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PC3Q65 Series

■ Design Considerations

Design guide

While operating at I_F<1.0mA, CTR variation may increase.

Please make design considering this fact.

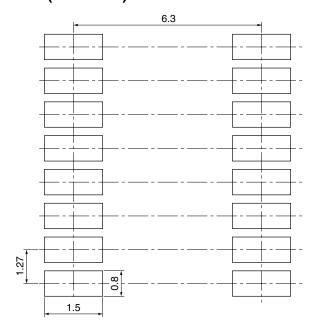
This product is not designed against irradiation and incorporates non-coherent IRED.

Degradation

In general, the emission of the IRED used in photocouplers will degrade over time.

In the case of long term operation, please take the general IRED degradation (50% degradation over 5years) into the design consideration.

Recommended Foot Print (reference)



(Unit: mm)

[☆] For additional design assistance, please review our corresponding Optoelectronic Application Notes.

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PC3Q65 Series

■ Manufacturing Guidelines

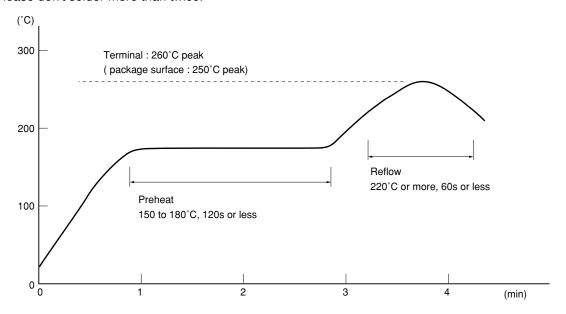
Soldering Method

Reflow Soldering:

Reflow soldering should follow the temperature profile shown below.

Soldering should not exceed the curve of temperature profile and time.

Please don't solder more than twice.



Flow Soldering:

Due to SHARP's double transfer mold construction submersion in flow solder bath is allowed under the below listed guidelines.

Flow soldering should be completed below 260°C and within 10s.

Preheating is within the bounds of 100 to 150°C and 30 to 80s.

Please don't solder more than twice.

Hand soldering

Hand soldering should be completed within 3s when the point of solder iron is below 400°C.

Please don't solder more than twice.

Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.



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Cleaning instructions

Solvent cleaning:

Solvent temperature should be 45°C or below Immersion time should be 3minutes or less

Ultrasonic cleaning:

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

Recommended solvent materials:

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances: CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform) Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.

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SHARP

■ Package specification

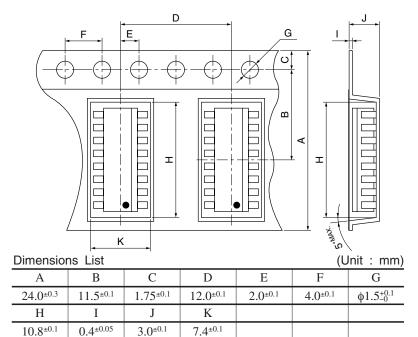
● Tape and Reel package

Package materials Carrier tape : PS

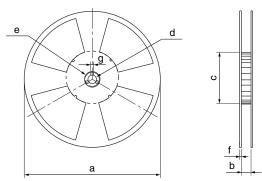
Cover tape : PET (three layer system)

Reel: PS

Carrier tape structure and Dimensions

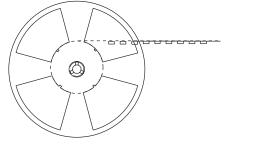


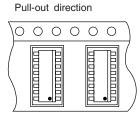
Reel structure and Dimensions



Dimensio	ns List	(Unit: mm)		
a	b	с	d	
330	25.5±1.5	100±1.0	13±0.5	
e	f	g		
23±1.0	2.0 ^{±0.5}	2.0 ^{±0.5}		

Direction of product insertion





[Packing: 1 000pcs/reel]

Sheet No.: D2-A01801EN

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 - --- Personal computers
 - --- Office automation equipment
 - --- Telecommunication equipment [terminal]
 - --- Test and measurement equipment
 - --- Industrial control
 - --- Audio visual equipment
 - --- Consumer electronics
- (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

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- --- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- --- Traffic signals
- --- Gas leakage sensor breakers
- --- Alarm equipment
- --- Various safety devices, etc.
- (iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:
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 - --- Telecommunication equipment [trunk lines]
 - --- Nuclear power control equipment
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